

### ECMF04-4HSM10

# Common mode filter with ESD protection for high speed serial interface

Datasheet - production data

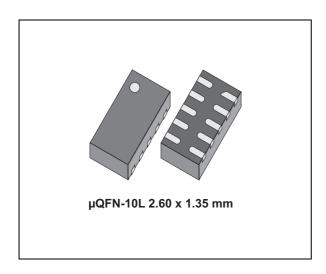
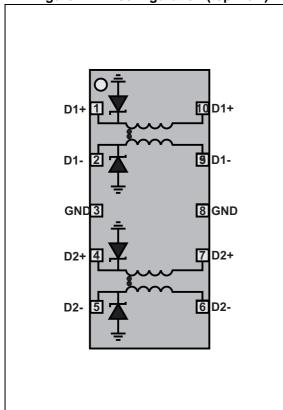


Figure 1. Pin configuration (top view)



#### **Features**

- Very large differential bandwidth to comply with HDMI Full HD, MIPI, USB2.0, USB3.0, Display Port and other high speed serial interfaces
- Provides -20 dB attenuation at 700 MHz in LTE bands
- High common mode attenuation:- 25 dB between 800 MHz - 900 MHz
- Very low PCB space consumption
- Thin package: 0.55 mm max.
- Lead-free package
- High reduction of parasitic elements through integration.

#### Complies with the following standards:

- IEC 61000-4-2 level 4:
  - ±15 kV (air discharge)
  - ±8 kV (contact discharge)

### **Applications**

- Mobile phones
- Notebook, laptop
- · Portable devices
- PND

### **Description**

This device is a highly integrated common mode filter designed to suppress EMI/RFI common mode noise on high speed differential serial buses like HDMI Full HD, MIPI, Display Port and other high speed serial interfaces. The device has a very large differential bandwidth to comply with these standards. The device can protect and filter 2 differential lanes.

Characteristics ECMF04-4HSM10

### 1 Characteristics

2/13

Table 1. Absolute maximum ratings ( $T_{amb} = 25 \text{ °C}$ )

Symbol	Par	Value	Unit	
V <sub>PP</sub>	Peak pulse voltage	IEC 61000-4-2 Contact discharge (connector side) Air discharge (connector side)	8 16	kV
I <sub>DC</sub>	Maximum DC current		100	mA
T <sub>op</sub>	Operating temperature range		-40 to +85	°C
T <sub>j</sub>	Maximum junction temperature		125	°C
T <sub>stg</sub>	Storage temperature range		- 55 to +150	°C

Figure 2. Electrical characteristics (definitions)

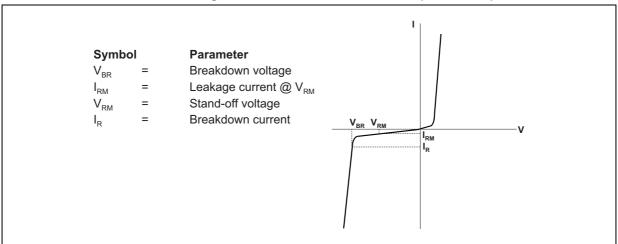


Table 2. Electrical characteristics (T<sub>amb</sub> = 25 °C)

Symbol	Test conditions	Min.	Тур.	Max.	Unit
$V_{BR}$	I <sub>R</sub> = 1 mA	6			V
I <sub>RM</sub>	V <sub>RM</sub> = 3 V per line			100	nA
R <sub>DC</sub>	DC serial resistance		5		Ω

Table 3. Pin description

Pin number	Description	Pin number	Description
1	D1+ to connector	6	D2- to IC
2	D1- to connector	7	D2+ to IC
3	GND	8	GND
4	D2+ to connector	9	D1- to IC
5	D2- to connector	10	D1+ to IC

ECMF04-4HSM10 **Characteristics** 

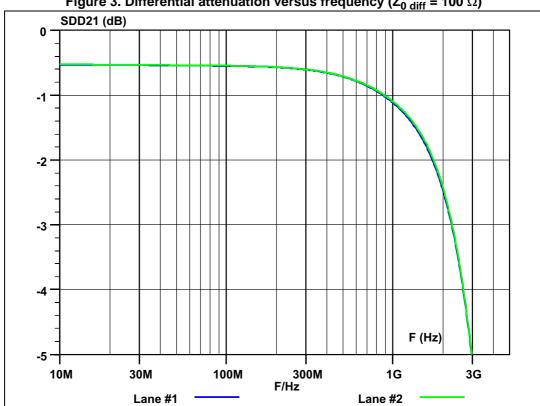
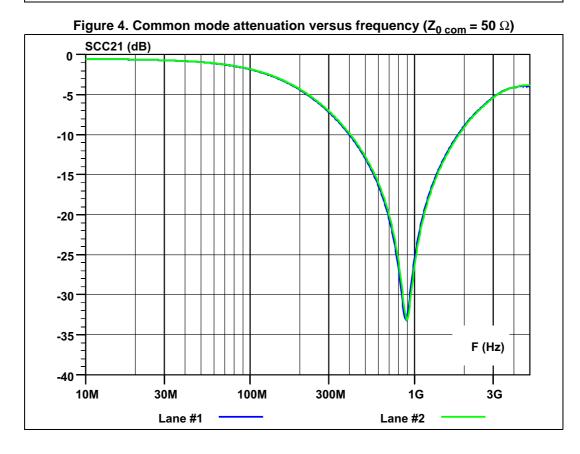


Figure 3. Differential attenuation versus frequency (Z<sub>0 diff</sub> = 100  $\Omega$ )



Characteristics ECMF04-4HSM10

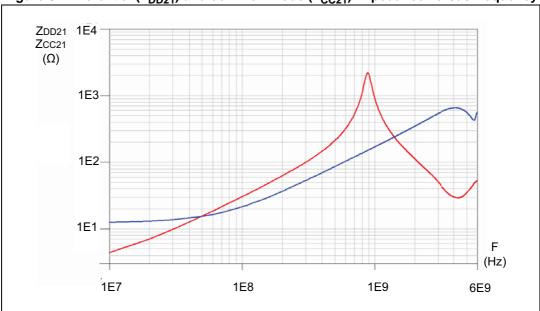
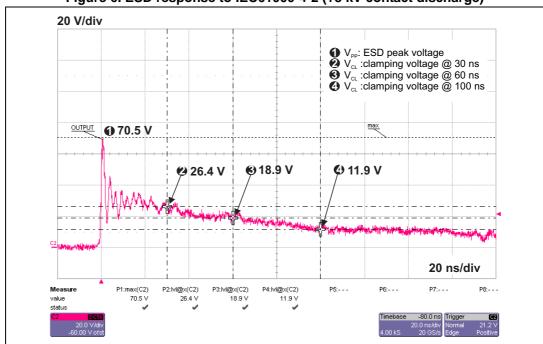


Figure 5. Differential (Z<sub>DD21</sub>) and common mode (Z<sub>CC21</sub>) impedance versus frequency





ECMF04-4HSM10 Characteristics

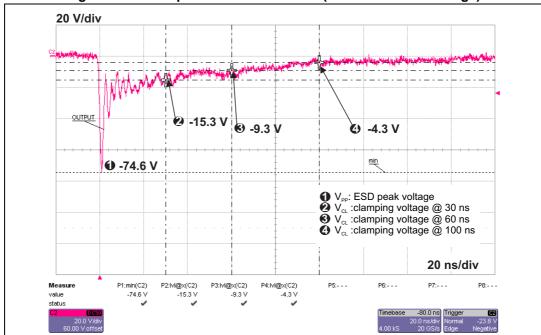
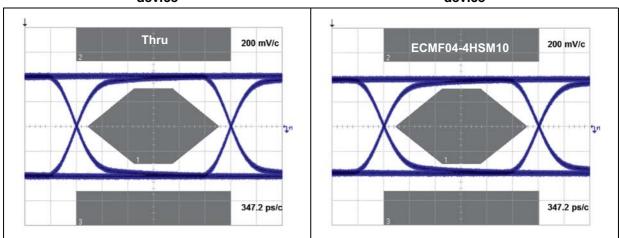


Figure 7. ESD response to IEC61000-4-2 (-8 kV contact discharge)

Figure 8. USB2.0 480 Mbps eye diagram without Figure 9. USB2.0 480 Mbps eye diagram with device Gevice



Characteristics ECMF04-4HSM10

Figure 10. USB3.0 5 Gbps eye diagram without device

Figure 11. USB3.0 5 Gbps eye diagram with device

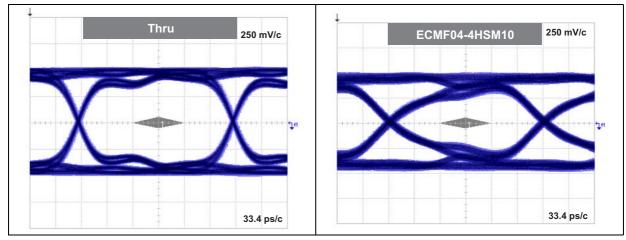
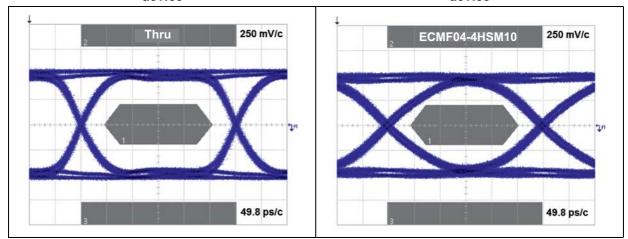


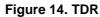
Figure 12. HDMI 3.35 Gbps eye diagram without device

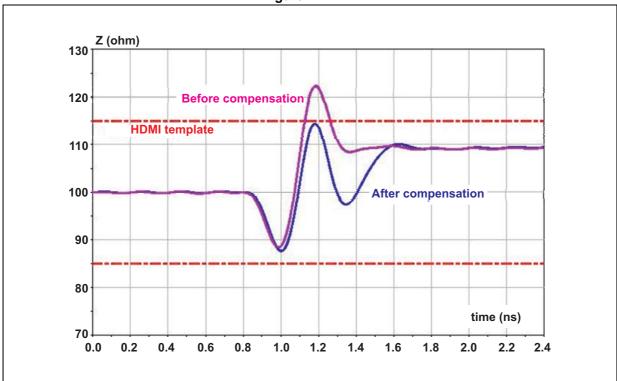
Figure 13. HDMI 3.35 Gbps eye diagram with device



6/13 DocID024844 Rev 2

ECMF04-4HSM10 Characteristics





# 2 Application information

Figure 15. HDMI schematic

More application information available in following AN:

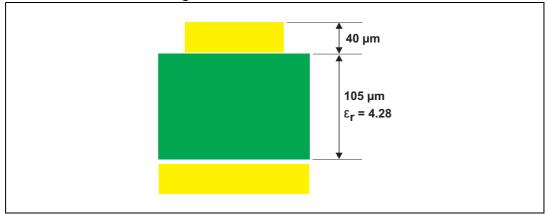
- Application Note AN4356: "Antenna desense on handheld equipment"
- Application Note AN4511: "Common Mode filters"
- Application Note AN4540: "MHL link filtering and protection"

#### **PCB** layout recommendations 3

Connector Host 5000 μm 350 µm 350 µm lanes  $(Z_0 = 100 \Omega)$  $(Z_0 = 100 \Omega)$ 

Figure 16. PCB layout recommendations





Package information ECMF04-4HSM10

## 4 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

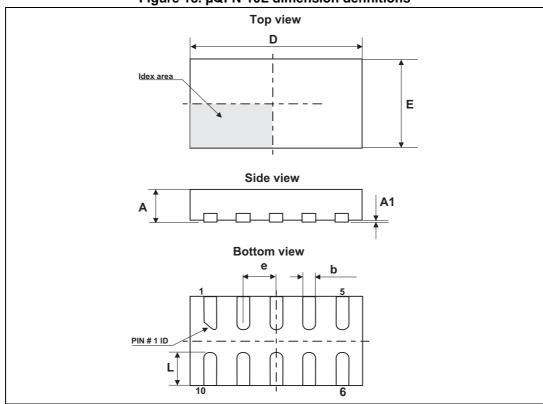


Figure 18. µQFN-10L dimension definitions

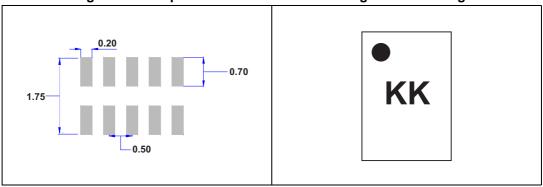
Table 4. µQFN-10L dimension values

Dimensions						
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	0.45	0.50	0.55	0.018	0.020	0.022
A1	0.00	0.02	0.05	0.00	0.0008	0.002
b	0.15	0.20	0.25	0.006	0.008	0.010
D	2.55	2.60	2.65	0.1	0.102	0.104
Е	1.30	1.35	1.40	0.051	0.053	0.055
е		0.50			0.020	
L	0.40	0.50	0.60	0.016	0.020	0.024

10/13 DocID024844 Rev 2

Figure 19. Footprint

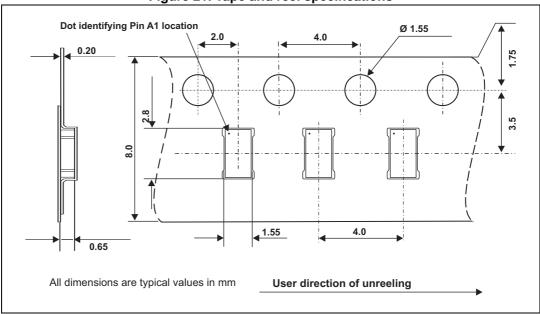
Figure 20. Marking



Note:

Product marking may be rotated by multiples of 90° for assembly plant differentiation. In no case should this product marking be used to orient the component for its placement on a PCB. Only pin 1 mark is to be used for this purpose.

Figure 21. Tape and reel specifications



Ordering information ECMF04-4HSM10

# 5 Ordering information

Figure 22. Ordering information scheme

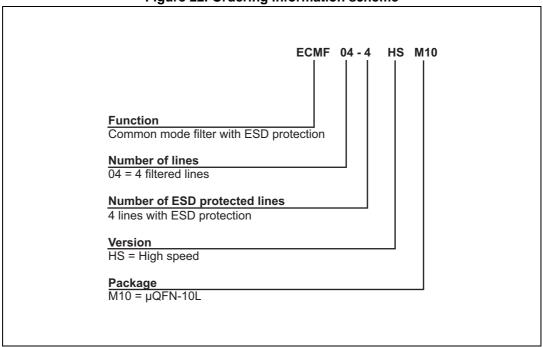


Table 5. Ordering information

Order code	Marking <sup>(1)</sup>	Package	Weight	Base qty	Delivery mode
ECMF04-4HSM10	KK	μQFN-10L	5.00 mg	3000	Tape and reel

<sup>1.</sup> The marking can be rotated by multiples of  $90^\circ$  to differentiate assembly location

## 6 Revision history

Table 6. Document revision history

Date	Revision	Changes
03-Oct-2013	1	Initial release.
25-Aug-2014	2	Added Figure 5: Differential (ZDD21) and common mode (ZCC21) impedance versus frequency.

12/13 DocID024844 Rev 2

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